

<u>Description:</u> Giga-snaP BGA SMT Foot

60 position terminal pins (0.8mm x 1.0 mm centers, 6x12 array) to SMT solder balls (BGA type). Pin asignment 1:1.

 $\frac{\text{Tolerances:}}{\pm 0.03 \text{mm } [\pm 0.001"]}, \text{ PCB perimeters } \pm 0.13 \text{mm } [\pm 0.005"], \text{ PCB thicknesses } \pm 0.18 \text{mm } [\pm 0.007"], \text{ pitches (from true position)} \\ \pm 0.08 \text{mm } [\pm 0.003"], \text{ all other tolerances } \pm 0.13 \text{mm } [\pm 0.005"] \text{ unless stated otherwise.} \\ \text{Materials and specifications are subject to change without notice.}$

SF-BGA60G-B-61 Drawing	Status: Released	Scale	: 8:1	Rev: B
© 2009 IRONWOOD ELECTRONICS, INC. 11351 Rupp Drive, Suite 400, Burnsville, MN 55337 Tele: (952) 229-8200 www.ironwoodelectronics.com	Drawing: A. Evans		Date: 06/01/09	
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